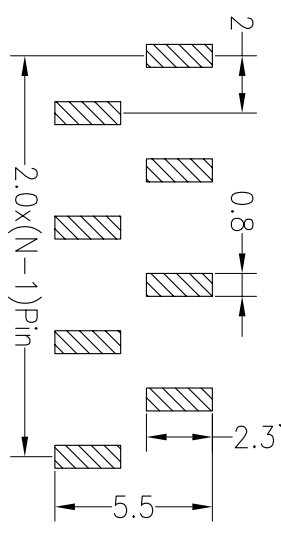
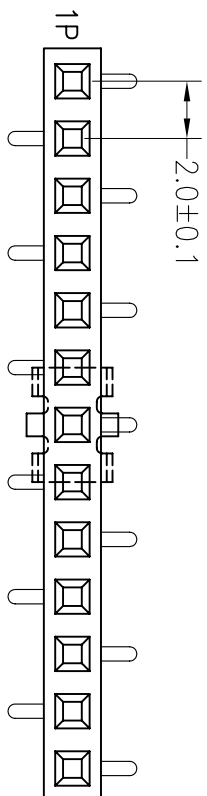


1 2 3 4 5 6 7 8 9

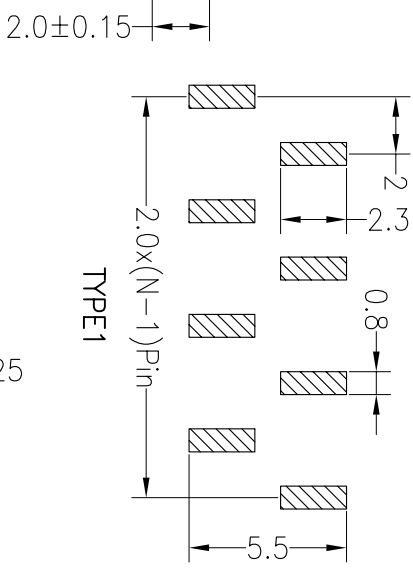
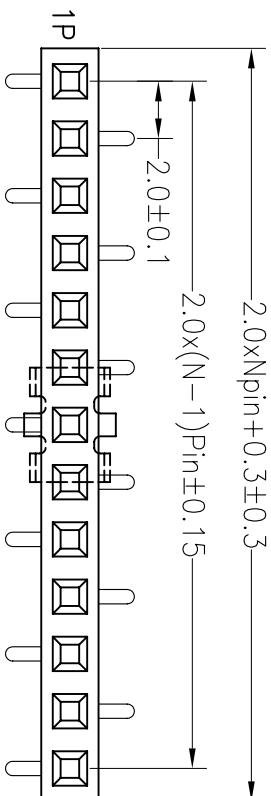
SPECIFICATIONS

Rated Current:1.5AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°c to +105°c

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



TYPE2



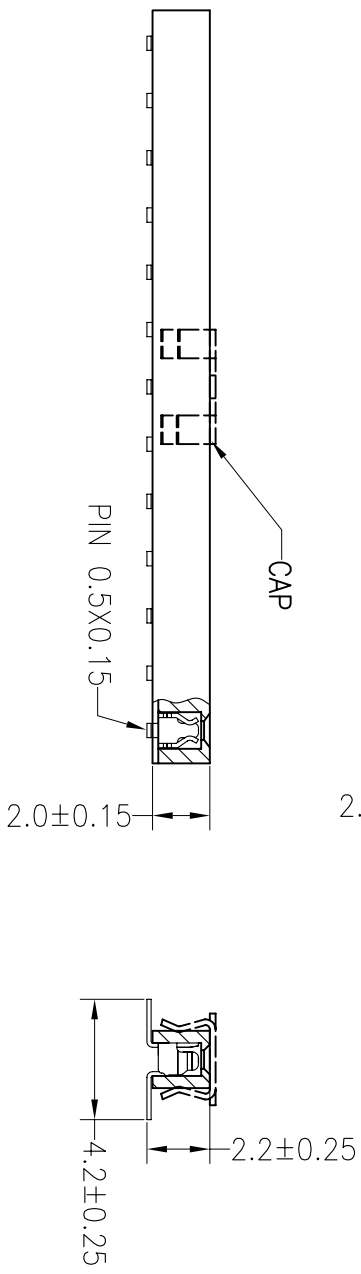
TYPE1

Contact Material:Phosphor Bronze
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)

Ordering Information

2320-01 XX X N XX M U OX

No. of Pins Per Row 1*40
 Insulator Material Option
 A=BK-PBT
 B=BK-PA66
 C=BK-PA6T
 D=BK-PA46
 F=BK-LCP
 Contact Plating
 G0:Gold Flash
 G2:5U" Gold
 G3:10U" Gold
 G4:15U" Gold
 G5:30U" Gold
 S0:Gold Flash/Tin
 SN:tin



OPERATION		DRAW		SCALE		FIT		BESTCONN(WUHAN) TECHNOLOGY CO.,LTD https://bsconnector.com/	
X.X	±0.30	Y.YuSheng		UNIT	mm	A4			
X.XX	±0.20	12.04.18		SIZE	A4	1/1			
X.XXX	±0.10	CHECK		SHEET	1/1	PART NO.		2320-01XXXXXXMUOX	
Angle	±3°	APPROVE		PROJ.		TITLE:		2.00PF H2.0mm 1xNpin SMT	
DIM	TOL								

MODIFICATION DESCRIPTION		CHANGE		REV		DATE			
NEW DRAWING				A0		2012.04.18			
1		2		3		4		5	

REV 1 DATE 2012.04.18
 MODIFICATION DESCRIPTION NEW DRAWING
 CHANGE 1 2 3 4 5 6 7 8 9